

STGP6M65DF2

Trench gate field-stop IGBT, M series 650 V, 6 A low loss

Datasheet - production data

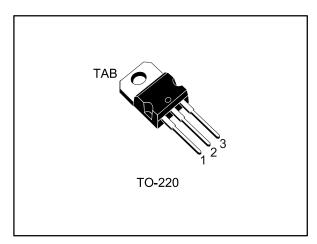
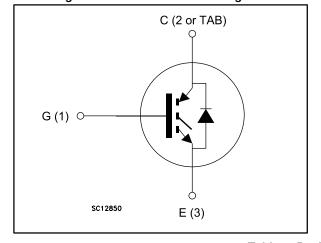


Figure 1: Internal schematic diagram



Features

- 6 μs of short-circuit withstand time
- $V_{CE(sat)} = 1.55 \text{ V (typ.)} @ I_C = 6 \text{ A}$
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{\text{CE(sat)}}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|-------------|----------|---------|---------|
| STGP6M65DF2 | G6M65DF2 | TO-220 | Tube |

Contents STGP6M65DF2

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STGP6M65DF2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|---|-------------|------|
| Vces | Collector-emitter voltage (V _{GE} = 0 V) | 650 | V |
| 1- | Continuous collector current at T _C = 25 °C | 12 | Α |
| lc | Continuous collector current at T _C = 100 °C | 6 | Α |
| ICP ⁽¹⁾ | Pulsed collector current | 24 | Α |
| V_{GE} | Gate-emitter voltage | ±20 | V |
| | Continuous forward current at T _C = 25 °C | 12 | Α |
| l _F | Continuous forward current at T _C = 100 °C | 6 | Α |
| I _{FP} ⁽¹⁾ | Pulsed forward current | 24 | Α |
| Ртот | Total dissipation at T _C = 25 °C | 88 | W |
| T _{STG} | Storage temperature range - 55 to 150 | | °C |
| TJ | Operating junction temperature range | - 55 to 175 | °C |

Notes:

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|--------|--|-------|------|
| RthJC | Thermal resistance junction-case IGBT | 1.7 | °C/W |
| RthJC | Thermal resistance junction-case diode | 5 | °C/W |
| RthJA | Thermal resistance junction-ambient | 62.5 | °C/W |

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by maximum junction temperature.

Electrical characteristics STGP6M65DF2

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 4: Static characteristics

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|----------------------|---|---|------|------|------|------|
| V _{(BR)CES} | Collector-emitter breakdown voltage | $V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$ | 650 | | | ٧ |
| | | $V_{GE} = 15 \text{ V}, I_{C} = 6 \text{ A}$ | | 1.55 | 2.0 | |
| V _{CE(sat)} | V _{CE(sat)} Collector-emitter saturation voltage | V _{GE} = 15 V, I _C = 6 A, T _J = 125 °C | | 1.9 | | V |
| Saturation voltage | odiaration voltage | V _{GE} = 15 V, I _C = 6 A, T _J = 175 °C | | 2.1 | | |
| | V _F Forward on-voltage | IF = 6 A | | 2.2 | | |
| V _F | | I _F = 6 A, T _J = 125 °C | | 2.0 | | V |
| | | I _F = 6 A, T _J = 175 °C | | 1.9 | | |
| V _{GE(th)} | Gate threshold voltage | $V_{CE} = V_{GE}, I_C = 250 \mu A$ | 5 | 6 | 7 | V |
| Ices | Collector cut-off current | V _{GE} = 0 V, V _{CE} = 650 V | | | 25 | μΑ |
| Iges | Gate-emitter leakage current | V _{CE} = 0 V, V _{GE} = ± 20 V | | | ±250 | μΑ |

Table 5: Dynamic characteristics

| Table 3. Dynamic characteristics | | | | | | |
|----------------------------------|------------------------------|--|------|------|------|------|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| Cies | Input capacitance | | - | 530 | - | |
| Coes | Output capacitance | V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0 V | - | 31 | 1 | pF |
| Cres | Reverse transfer capacitance | VOL = 20 V, T = T IIII 12, VGL = 0 V | - | 11 | 1 | ρ. |
| Qg | Total gate charge | Vcc = 520 V, Ic = 6 A, VgE = 15 V | - | 21.2 | 1 | |
| Q _{ge} | Gate-emitter charge | (see Figure 30: " Gate charge test | - | 5.2 | - 1 | nC |
| Qgc | Gate-collector charge | circuit") | - | 8.8 | - | |

Table 6: IGBT switching characteristics (inductive load)

| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | Table 6: IGBT switching characteristics (inductive load) | | | | | | |
|--|--|-----------|--|------|-------|------|------|
| t time t Current rise time (di/dt)on Turn-off-delay time t Current fall time Eon(1) Turn-off-switching energy Et Current rise time Current rise time Vc∈ = 400 V, lc = 6 A, Vc∈ = 15 V, Rc = 22 Ω (see Figure 29: "Test circuit for inductive load switching") Turn-off switching energy Et Current rise time t Current rise time (di/dt)on Turn-on delay time t Current rise time (di/dt)on Turn-on current slope to Current fall time Turn-off-delay time Vc∈ = 400 V, lc = 6 A, Vc∈ = 15 V, Rc = 22 Ω (see Figure 29: "Test circuit for inductive load switching") D.200 □ □ 170 □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ | Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| time (di/dt)on current slope to (di/dt)on current slope time | t _{d(on)} | | | | 15 | - | ns |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | t _r | | | | 5.8 | - | ns |
| time t₁ Current fall time Turn-on switching energy E _{off} (2) Total switching energy t_{t} Turn-on delay time tr Current rise time (di/dt) _{on} Turn-on current slope t₁ Turn-on switching energy t_{t} Turn-on delay time t_{t} t_{t} t_{t} Turn-on delay time t_{t} t_{t} t_{t} Turn-on delay time t_{t} | (di/dt) _{on} | | | | 828 | - | A/μs |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | t _{d(off)} | | V 400 V I CA V 45 V | | 90 | - | ns |
| | tf | | R _G = 22 Ω (see Figure 29: "Test circuit | | 130 | - | ns |
| | E _{on} (1) | switching | | | 0.036 | - | mJ |
| to the content of the time to the time | E _{off} (2) | switching | | | 0.200 | - | mJ |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | E _{ts} | | | | 0.236 | - | mJ |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | t _{d(on)} | - | | | 17 | - | ns |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | tr | | | | 7 | - | ns |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | (di/dt) _{on} | | | | 685 | ı | A/μs |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | t _{d(off)} | • | V 400 V I 6 A V 15 V | | 86 | - | ns |
| | tf | | $R_G = 22 \Omega T_J = 175 ^{\circ}\text{C}$ (see <i>Figure 29:</i> " | | 205 | - | ns |
| | E _{on} (1) | switching | , | | 0.064 | - | mJ |
| Ets energy 0.354 - Short-circuit Vcc ≤ 400 V, V _{GE} = 15 V, T _{Jstart} = 150 °C 6 - | E _{off} (2) | switching | | | 0.290 | - | mJ |
| | E _{ts} | _ | | | 0.354 | - | mJ |
| | + | | $V_{CC} \le 400 \text{ V}, V_{GE} = 15 \text{ V}, T_{Jstart} = 150 \text{ °C}$ | 6 | | - | μs |
| withstand time $V_{CC} \le 400 \text{ V}, V_{GE} = 13 \text{ V}, T_{Jstart} = 150 \text{ °C}$ 10 - | t _{sc} | | $V_{CC} \le 400 \text{ V}, V_{GE} = 13 \text{ V}, T_{Jstart} = 150 \text{ °C}$ | 10 | | - | μs |

Notes:

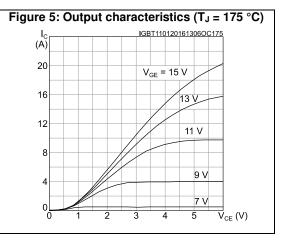
 $^{^{(1)}}$ Turn-on switching energy includes reverse recovery of the diode.

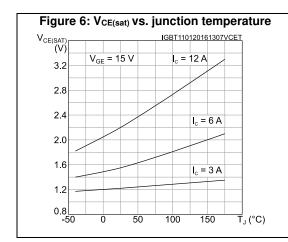
 $[\]ensuremath{^{(2)}}\mbox{Turn-off}$ switching energy also includes the tail of the collector current.

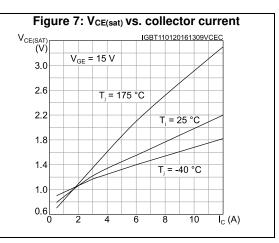
Table 7: Diode switching characteristics (inductive load)

| Symbol | Parameter Test conditions | | | Тур. | Max. | Unit |
|----------------------|---|---|------|-------|--------|-------|
| Symbol | i arameter | rest conditions | Min. | i yp. | IVIAA. | Oilit |
| trr | Reverse recovery time | | - | 140 | | ns |
| Q _{rr} | Reverse recovery charge | | - | 210 | | nC |
| I _{rrm} | Reverse recovery current | I _F = 6 A, V _R = 400 V, V _{GE} = 15 V (see <i>Figure 29: " Test circuit for inductive load switching"</i>) di/dt = 1000 A/μs | | 6.6 | | Α |
| dl _{rr} /dt | Peak rate of fall of reverse recovery current during tb | | | 430 | | A/μs |
| Err | Reverse recovery energy | | | 16 | | μJ |
| t _{rr} | Reverse recovery time | | | 200 | | ns |
| Qrr | Reverse recovery charge | | - | 473 | | nC |
| I _{rrm} | Reverse recovery current | I _F = 6 A, V _R = 400 V, V _{GE} = 15 V T _J = 175 °C (see <i>Figure 29: " Test circuit for inductive load switching"</i>) | - | 9.6 | | Α |
| dl _{rr} /dt | Peak rate of fall of reverse recovery current during to | di/dt = 1000 A/μs | - | 428 | | A/μs |
| Err | Reverse recovery energy | | - | 32 | | μЈ |

2.1 Electrical characteristics (curves)







8

10⁰

Figure 8: Collector current vs. switching frequency

| Collector current vs. switching frequency
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| Collector current vs. switching frequency
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| Collector current vs. switching frequency vs. switching frequency
| Collector current vs. switching frequency v

f (kHz)

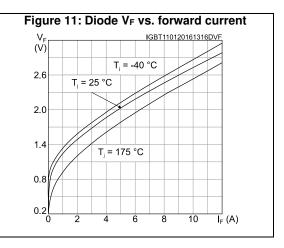
Rectangular current shape (duty cycle = 0.5, V_{cc} = 400 V R_{s} = 22 Ω , V_{GE} = 0/15 V,

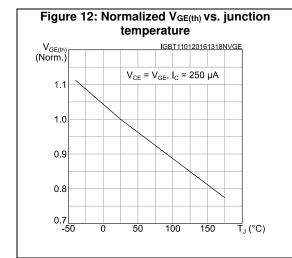
10¹

10²

T = 175 °C

Figure 9: Forward bias safe operating area $\begin{array}{c|c} I_{C} & \text{IGBT110120161310FSOA} \\ \hline (A) & \text{single pulse, } T_{c} = 25^{\circ}C, \\ \hline T_{J} \leq 175^{\circ}C, \ V_{GE} = 15 \ V \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{single pulse, } T_{c} = 25^{\circ}C, \\ \hline T_{J} \leq 175^{\circ}C, \ V_{GE} = 15 \ V \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 25^{\circ}C, \\ \hline T_{J} \leq 175^{\circ}C, \ V_{GE} = 15 \ V \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 100 \ \mu\text{s} \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 100 \ \mu\text{s} \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 100 \ \mu\text{s} \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 100 \ \mu\text{s} \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 100 \ \mu\text{s} \\ \hline \end{array}$ $\begin{array}{c|c} I_{C} & \text{the pulse, } T_{C} = 100 \ \mu\text{s} \\ \hline \end{array}$





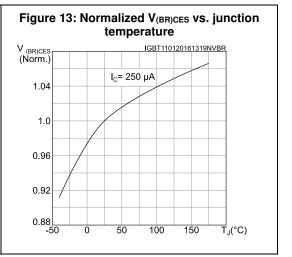


Figure 14: Capacitance variations

C
(pF)

10²

10¹

f = 1 MHz

C
C
ros

10⁰

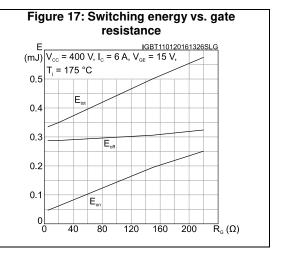
10⁻¹

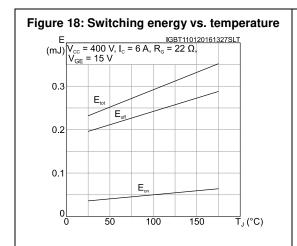
10⁰

10¹

10²

V_{CE} (V)





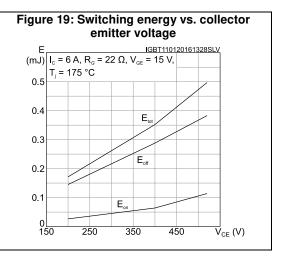


Figure 20: Short-circuit time and current vs.

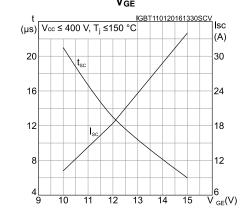


Figure 21: Switching times vs. collector current

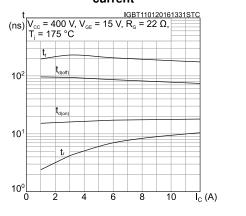


Figure 22: Switching times vs. gate resistance

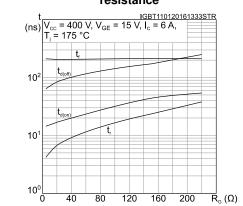


Figure 23: Reverse recovery current vs. diode current slope

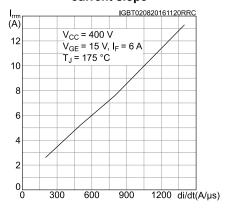


Figure 24: Reverse recovery time vs. diode current slope

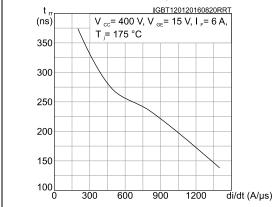
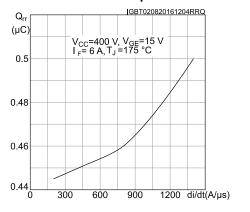
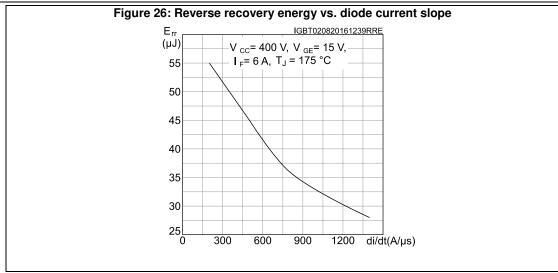
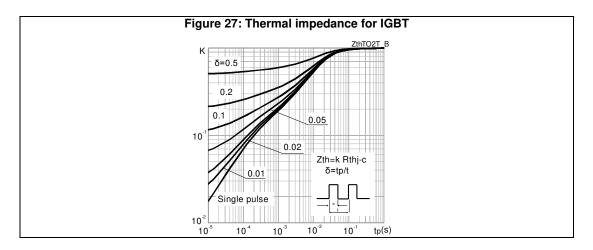
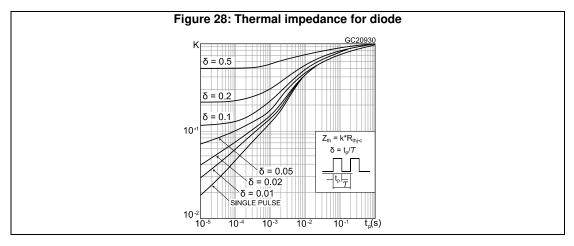


Figure 25: Reverse recovery charge vs. diode current slope



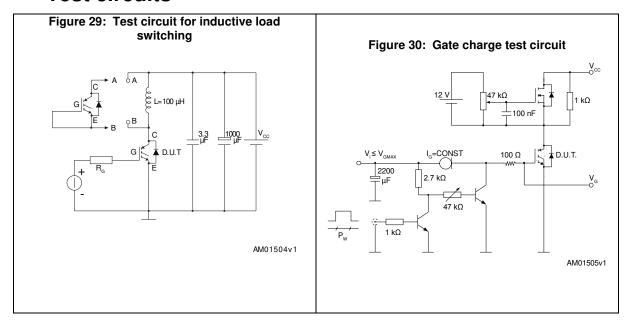


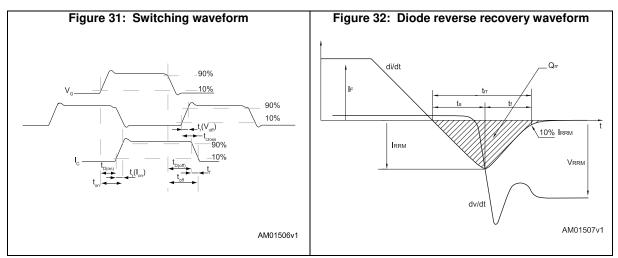




Test circuits STGP6M65DF2

3 Test circuits





STGP6M65DF2 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220 type A package information

Figure 33: TO-220 type A package outline

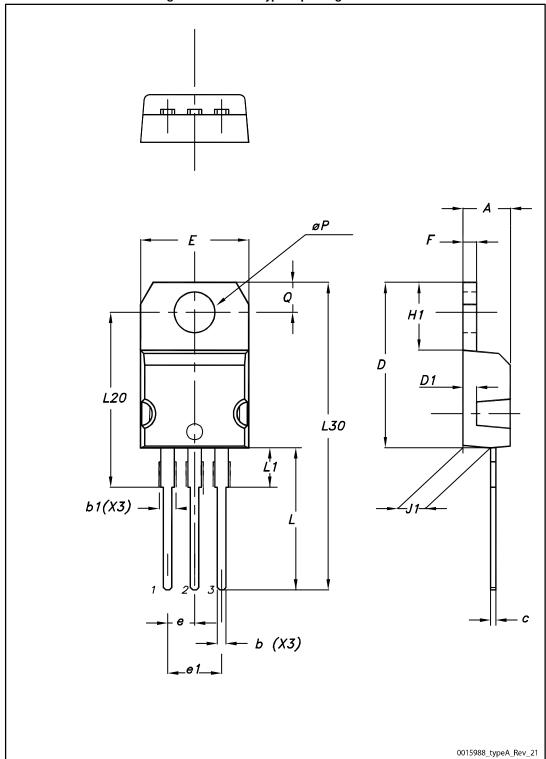


Table 8: TO-220 type A mechanical data

| | 145.001.0 ===0 typ | | |
|------|--------------------|-------|-------|
| Dim. | | mm | |
| Dim. | Min. | Тур. | Max. |
| Α | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.55 |
| С | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| Е | 10.00 | | 10.40 |
| е | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13.00 | | 14.00 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| øΡ | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Revision history STGP6M65DF2

5 Revision history

Table 9: Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 30-Nov-2015 | 1 | First release. |
| 13-Jan-2016 | 2 | Modified: Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 6: "IGBT switching characteristics (inductive load)", and Table 7: "Diode switching characteristics (inductive load)" Added: Section 2.1: "Electrical characteristics (curves)" Minor text changes. |
| 03-Aug-2016 | 3 | Updated Table 2: "Absolute maximum ratings", Table 4: "Static characteristics", Table 6: "IGBT switching characteristics (inductive load)", Table 7: "Diode switching characteristics (inductive load)". Updated Figure 9: "Forward bias safe operating area", Figure 12: "Normalized VGE(th) vs. junction temperature", Figure 20: "Short-circuit time and current vs. VGE", Figure 23: "Reverse recovery current vs. diode current slope". Changed Figure 25: "Reverse recovery charge vs. diode current slope" and Figure 26: "Reverse recovery energy vs. diode current slope". |

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